

RoHS

COMPLIANT

HALOGEN FREE

# **IRFU5410PBF-VB** Datasheet

# P-Channel 100 V (D-S) MOSFET

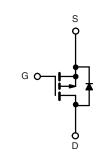
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (Ω)</b>	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)	
- 100	0.100 at V <sub>GS</sub> = - 10 V	- 16	11.7	
- 100	0.120 at $V_{GS}$ = - 4.5 V	- 15	11.7	

## **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested
  Compliant to RoHS Directive 2002/95/EC

## **APPLICATIONS**

- Power Switch
- DC/DC Converters •



P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> T <sub>C</sub> = 25 °C, unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 100	N		
Gate-Source Voltage	V <sub>GS</sub>	± 20	V		
Continuous Drain Current (T 150 °C)	T <sub>C</sub> = 25 °C	I-	- 16		
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C	Ι <sub>D</sub>	- 14		
Pulsed Drain Current	I <sub>DM</sub>	- 50	A		
Avalanche Current	I <sub>AS</sub>	- 18			
Single Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	16.2	mJ	
	T <sub>C</sub> = 25 °C	D	32.1 <sup>b</sup>	w	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C <sup>c</sup>	P <sub>D</sub>	2.5		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

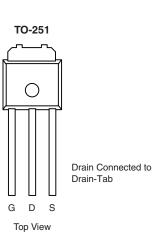
THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) <sup>c</sup>	R <sub>thJA</sub>	50	°C/W		
Junction-to-Case (Drain)	R <sub>thJC</sub>	3.9	0/00		

Notes:

a. Duty cycle  $\leq$  1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).



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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		· · · · · · · · · · · · · · · · · · ·		•			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>DS</sub> V <sub>DS</sub> = 0 V, I <sub>D</sub> = - 250 μA - 100				N	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 2.5	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 100 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			- 50		
		$V_{DS}$ = - 100 V, $V_{GS}$ = 0 V, $T_{J}$ = 150 °C			- 250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le$ - 10 V, $V_{GS}$ = - 10 V	- 15			А	
	P	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3.6 A		0.100			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.4 A		0.120		Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 3.6 A		12		S	
Dynamic <sup>b</sup>		· · · ·					
Input Capacitance	C <sub>iss</sub>			1055		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = - 50 V, f = 1 MHz		65			
Reverse Transfer Capacitance	C <sub>rss</sub>			41			
Tatal Cata Charge	Q <sub>g</sub> V	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.6 \text{ A}$		23.2	34.8	nC	
Total Gate Charge <sup>c</sup>				11.7	17.6		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS}$ = - 50 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 3.6 A		3.5			
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			4.8			
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			7	14		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = - 50 V, $R_L$ = 17.2 $\Omega$		12	18	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong$ - 2.9 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		33	50		
Fall Time <sup>c</sup>	t <sub>f</sub>			9	18		
Drain-Source Body Diode Ratings an	nd Characteri	stics T <sub>C</sub> = 25 °C <sup>b</sup>					
Continuous Current	۱ <sub>S</sub>				- 8.8		
Pulsed Current	I <sub>SM</sub>				- 15	- A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{F} = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.5	V	
Reverse Recovery Time	t <sub>rr</sub>			50	75	ns	
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	А	
Reverse Recovery Charge	Q <sub>rr</sub>	1 1		98	147	nC	

Notes:

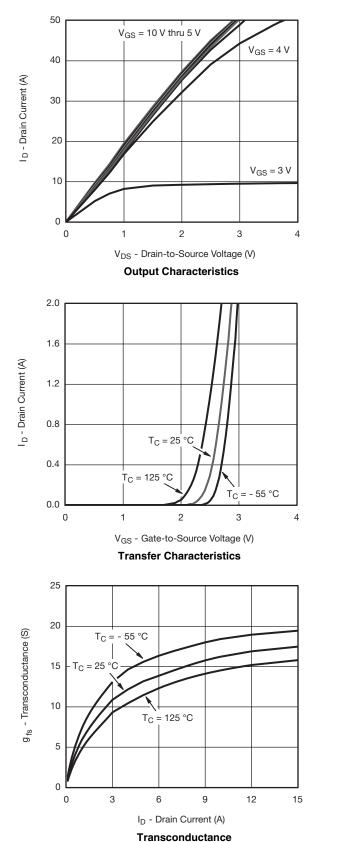
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

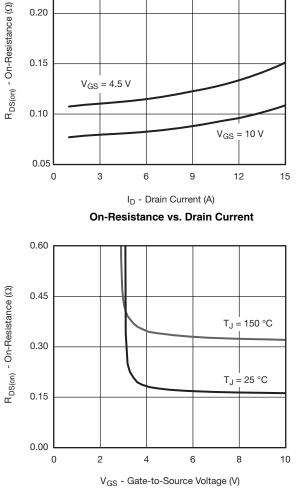
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

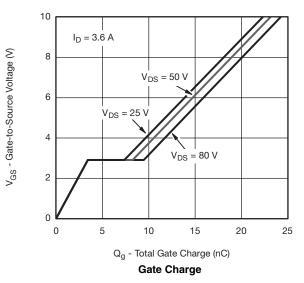


0.25

0.20

0.15

**On-Resistance vs. Gate-to-Source Voltage** 

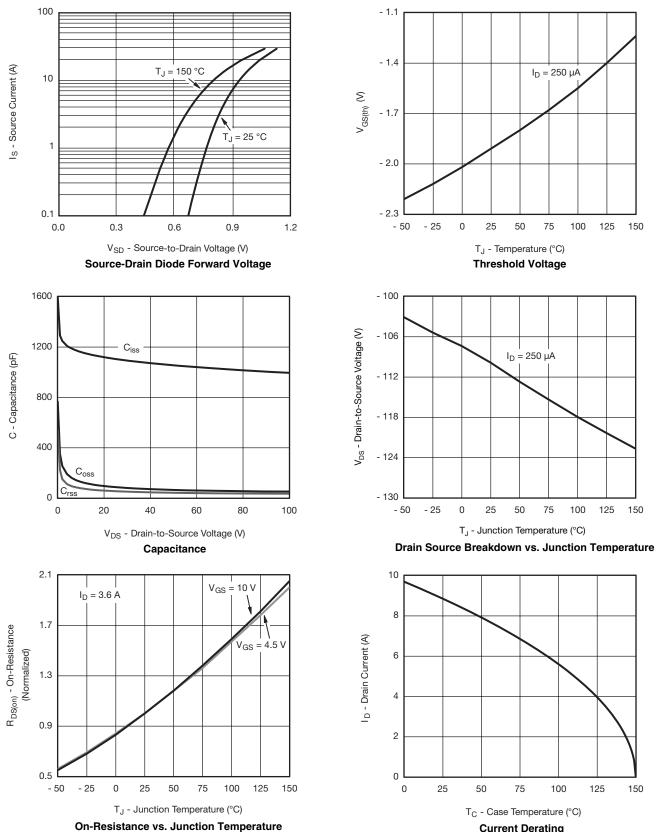




150

150

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

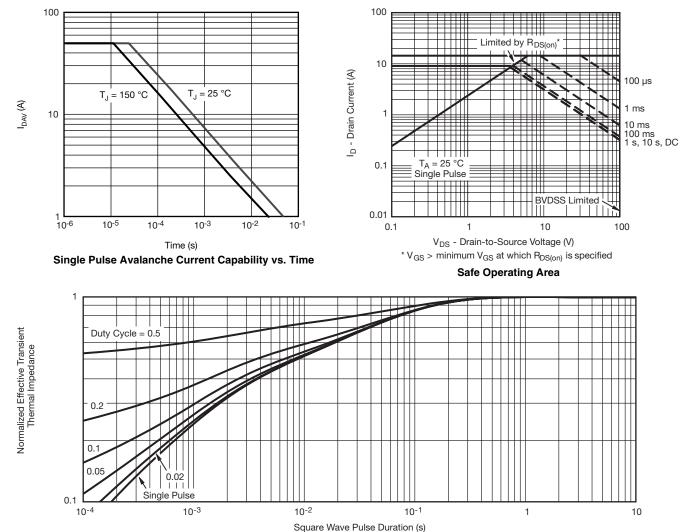


**Current Derating** 

150



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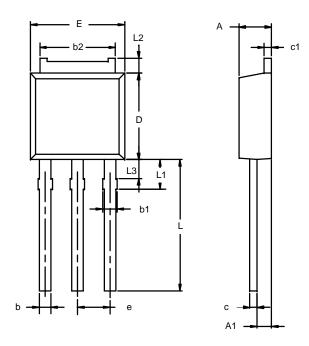


Normalized Thermal Transient Impedance, Junction-to-Case

# IRFU5410PBF-VB



#### **TO-251AA**



	MILLIM	IETERS	INC	HES Max	
Dim	Min	Max	Min		
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090	BSC	
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	

Note: Dimension L3 is for reference only.



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